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Product Change Notification - JAON-15QOAD468 (Printer Friendly)

Date:

18 Jan 2018

Product Category:

Energy Measurement

Notification subject:

CCB 3110 Final Notice: Qualification of MCP39F501, MCP39F511, MCP39F511N and MCP39F521 device families available in 28L QFN package with MSL 1 classification at NSEB assembly site.

Notification text:

PCN Status:

Final notification

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of MCP39F501, MCP39F511, MCP39F511N and MCP39F521 device families available in 28L QFN package with MSL 1 classification at NSEB assembly site using G700LTD mold compound and 8600 die attach material.

Pre Change:

Assembled at NSEB assembly site with MSL-3 classification using G770HCD mold compound, 8200T die attach material

Post Change:

Assembled at NSEB assembly site with MSL-1 classification using G700LTD mold compound, 8600 die attach material

Pre and Post Change Summary:

| | Pre Change | Post Change | | | |
|---------------------------|--------------------------|-----------------------------|--|--|--|
| Assembly Site | UTAC Thai Limited (NSEB) | UTAC Thai Limited (NSEB) | | | |
| Wire material | Au wire | Au wire | | | |
| Die attach material | 8200T/HR-5104-25 | 8600/HR-5104-25 | | | |
| Molding compound material | G770HCD | G700LTD | | | |
| Lead frame material | EFTEC64T | EFTEC64T | | | |



| MSL Classification | MSL - 3 | MSL - 1 |
|--------------------|---------|---------|

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve productivity and qualify selected products with MSL-1 classification using G700LTD mold compound, 8600 die attach material

Change Implementation Status:

In Progress

Estimated First Ship Date:

February 17, 2018 (date code: 1807)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

| | January 2018 | | | | February 2018 | | | |
|-------------------------------------|-----------------|----|----|----|------------------|----|----|----|
| Workweek | 01 | 02 | 03 | 04 | 05 | 06 | 07 | 08 |
| Qual Report Availability | | | Х | | | | | |
| Final PCN Issue Date | | | Х | | | | | |
| Estimated Implementation Date | | | | | | | Х | |

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History:

January 18, 2018: Issued final notification

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_JAON-15QOAD468_Affected_CPN.pdf PCN_JAON-15QOAD468_Qual_Report.pdf PCN_JAON-15QOAD468_Affected_CPN.xlsx

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